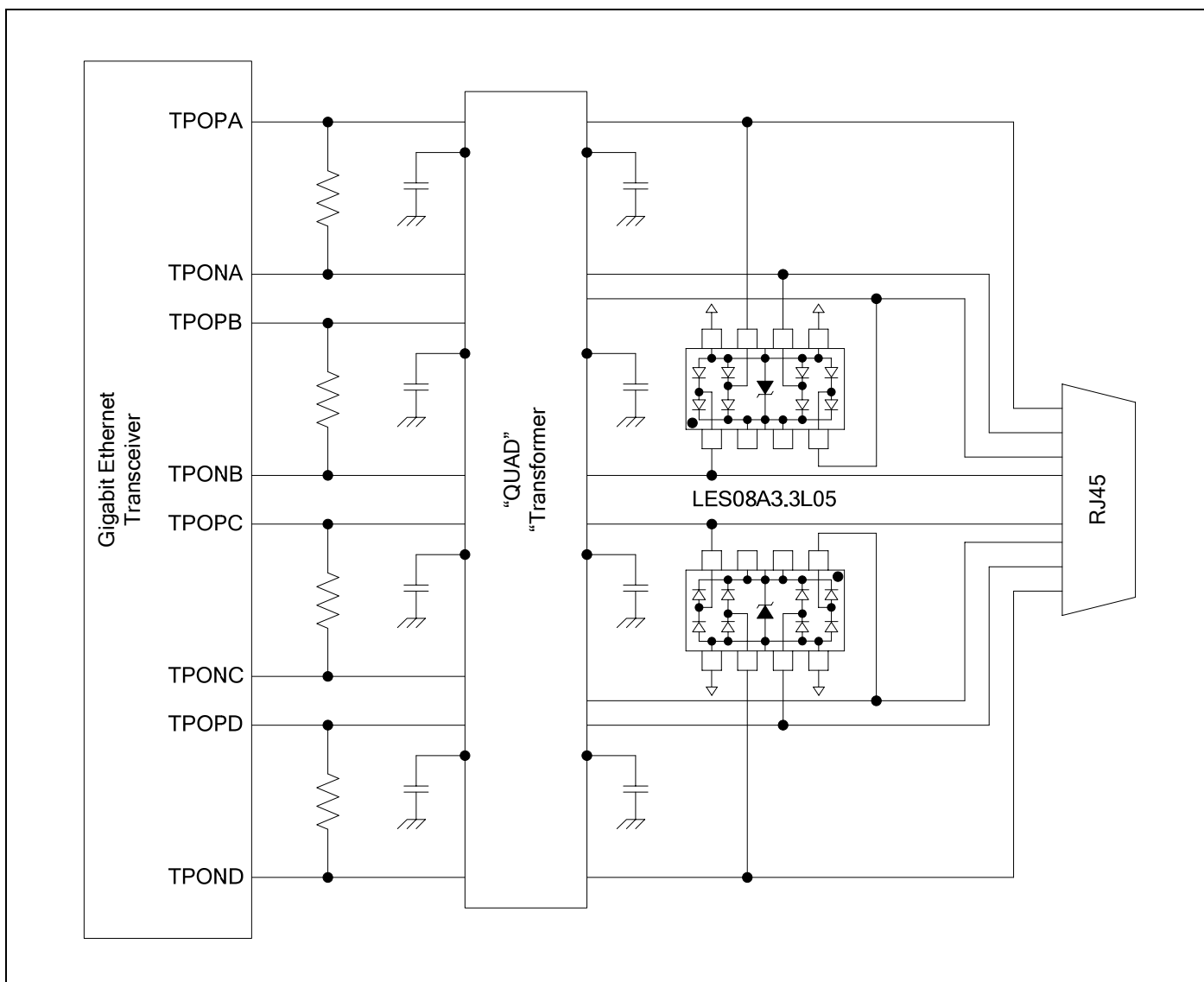


Electrical Characteristics (T_J=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V _{RWM}				3.3	V
Reverse breakdown voltage	V _{BR}	I _{BR} =1mA	4			V
Reverse leakage current	I _R	V _R =3.3V Each I/O pin			40	μA
Clamping voltage (tp=8/20μs)	V _C	I _{PP} =1A			8.5	V
Clamping voltage (tp=8/20μs)	V _C	I _{PP} =10A			10.9	V
Off state junction capacitance	C _J	0Vdc, f=1MHz Between I/O pins and GND			15	pF

Applications Information



Typical Characteristics Curves

Figure 1. Power Derating Curve

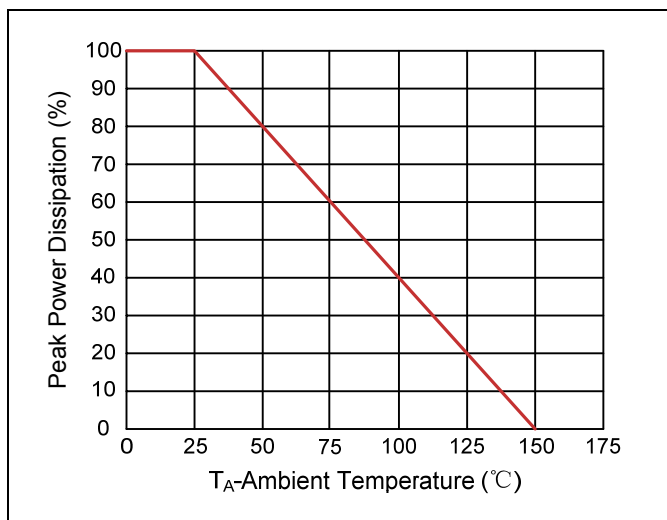


Figure 2. Pulse Waveforms

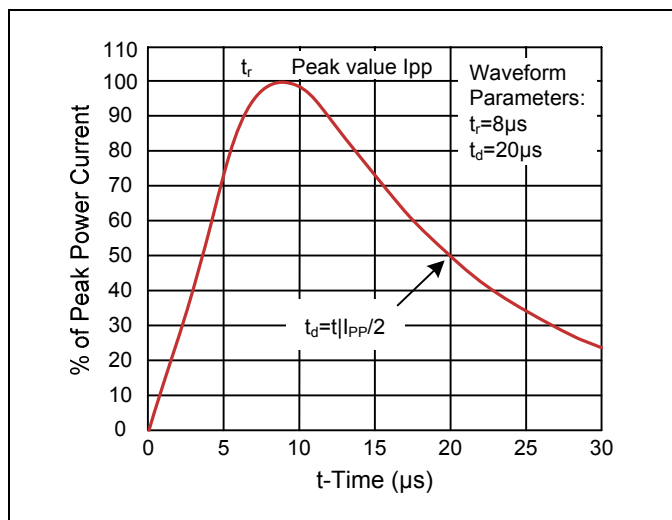


Figure 3. Non-Repetitive Peak Pulse vs. Pulse Time

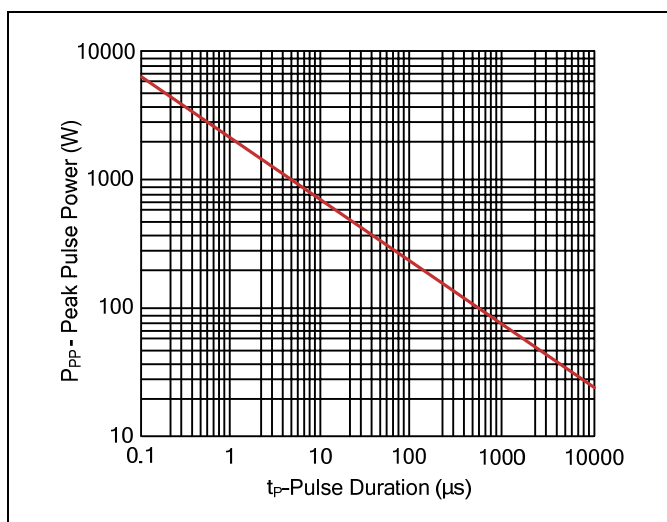
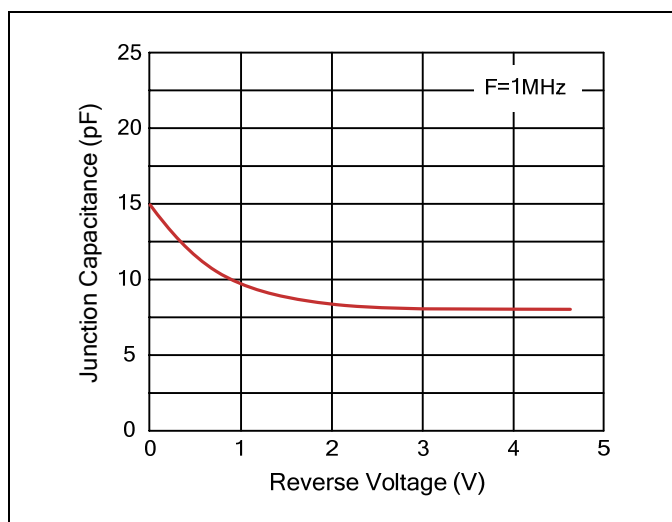
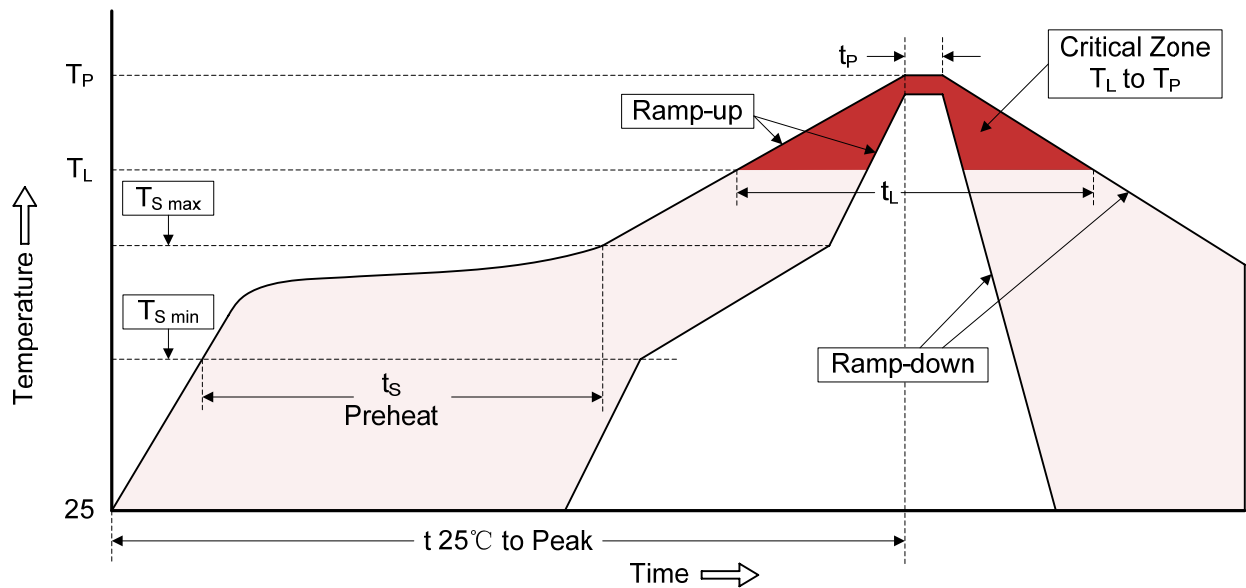


Figure 4. Capacitance vs. Reverse Voltage



Recommended Soldering Conditions

Reflow Soldering



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) (t_s)	150°C 200°C 60-180 seconds
$T_{S\ max}$ to T_L -Ramp-up Rate	3°C/second max.
Time maintained above: -Temperature (T_L) -Time (t_L)	217°C 60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

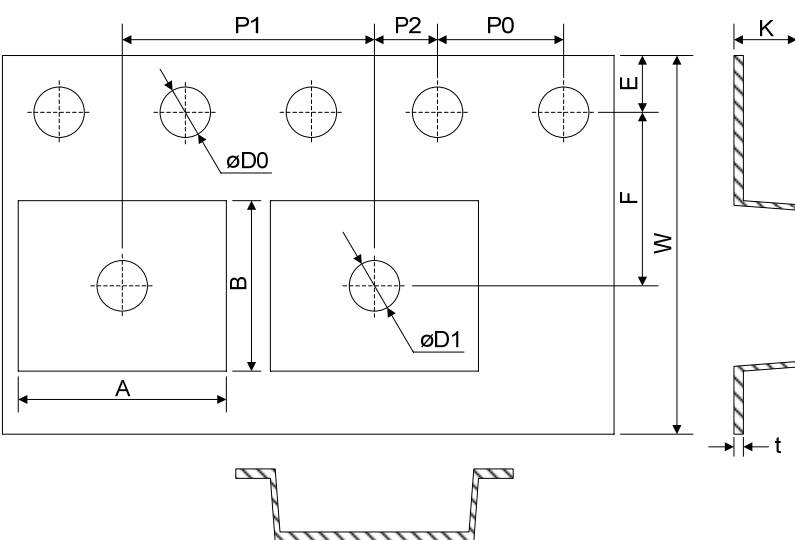
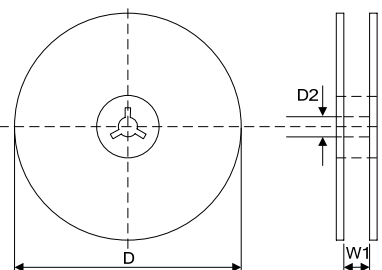
Dimensions (SOIC-08)

Technical drawing of an SOIC-08 package showing dimensions A through H2. The top view shows a rectangular package with eight pins, numbered 1 through 8. Dimensions A, B, C, D, E, F, G, and H are indicated. The side view shows the package profile with dimensions H1 and H2. The recommended soldering pad layout shows the dimensions for the pads, including 1.20 (8X), 0.73 (8X), and 1.27.

Recommended Soldering Pad Layout

Symbol	Dimension			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.80	5.00	0.189	0.197
B	5.80	6.20	0.228	0.244
C	3.80	4.00	0.150	0.157
D	1.27		0.050	
E	0.33	0.51	0.013	0.020
F	0.40	1.27	0.016	0.050
G	0.19	0.25	0.007	0.010
H	1.35	1.75	0.053	0.069
H1	0.10	0.25	0.004	0.010
H2	1.45		0.057	

Packaging

Tape 	Symbol	Dimension (mm)
	W	12.00±0.30
	P0	4.00±0.10
	P1	8.00±0.10
	P2	2.00±0.10
	D0	Φ1.55±0.10
	D1	Φ1.55±0.05
	E	1.75±0.10
	F	5.50±0.10
	A	6.50±0.10
	B	5.40±0.10
	K	2.00±0.10
	t	0.30±0.05
	D	Φ330.0±3.0
	D2	Φ13.0
Reel 	W1	13.5
	Quantity: 2500PCS	